



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





Inductors for Power Circuits

Wound Metal

VLS-HBX-1 Series

VLS252010HBX-1 Type

VLS252010HBX-1

REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using these products.

REMINDERS

- The storage period is less than 12 months. Be sure to follow the storage conditions (Temperature: 5 to 40°C, Humidity: 10 to 75% RH or less).
If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
- Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).
- Before soldering, be sure to preheat components.
The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications.
If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.
- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Carefully lay out the coil for the circuit board design of the non-magnetic shield type.
A malfunction may occur due to magnetic interference.
- Use a wrist band to discharge static electricity in your body through the grounding wire.
- Do not expose the products to magnets or magnetic fields.
- Do not use for a purpose outside of the contents regulated in the delivery specifications.
- The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition.
The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property.
If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions set forth in the each catalog, please contact us.

- (1) Aerospace/Aviation equipment
- (2) Transportation equipment (cars, electric trains, ships, etc.)
- (3) Medical equipment
- (4) Power-generation control equipment
- (5) Atomic energy-related equipment
- (6) Seabed equipment
- (7) Transportation control equipment

- (8) Public information-processing equipment
- (9) Military equipment
- (10) Electric heating apparatus, burning equipment
- (11) Disaster prevention/crime prevention equipment
- (12) Safety equipment
- (13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.

Inductors for Power Circuits

Product compatible with RoHS directive

Halogen-free

Wound Metal

Compatible with lead-free solders

Overview of VLS252010HBX-1 Type

FEATURES

- Magnetic shield type wound inductor for power circuits using a metallic magnetic material.
- High magnetic shield construction and compatible with high-density mounting.
- Larger current was achieved by the metallic magnetic material.

APPLICATION

Smart phones, tablet terminals, HDDs, SSDs, DVCs, DSCs, mobile display panels, portable game devices, compact power supply modules, other

PART NUMBER CONSTRUCTION

VLS	252010	HB	X	-	R24	M	-	1
Series name	LxWxH Dimensions (mm)		internal code 1	internal code 2	Inductance (μH)		Inductance tolerance	
	252010	2.5x2.0x1.0			R24	0.24	M	±20%
					2R2	2.2		
					100	10		


OPERATING TEMPERATURE RANGE, PACKAGE QUANTITY, PRODUCT WEIGHT

Type	Temperature range		Package quantity (pieces/reel)	Individual weight (mg)
	Operating temperature* (°C)	Storage temperature** (°C)		
VLS252010HBX-1	-40 to +105	-40 to +105	2000	26

* Operating temperature range includes self-temperature rise.

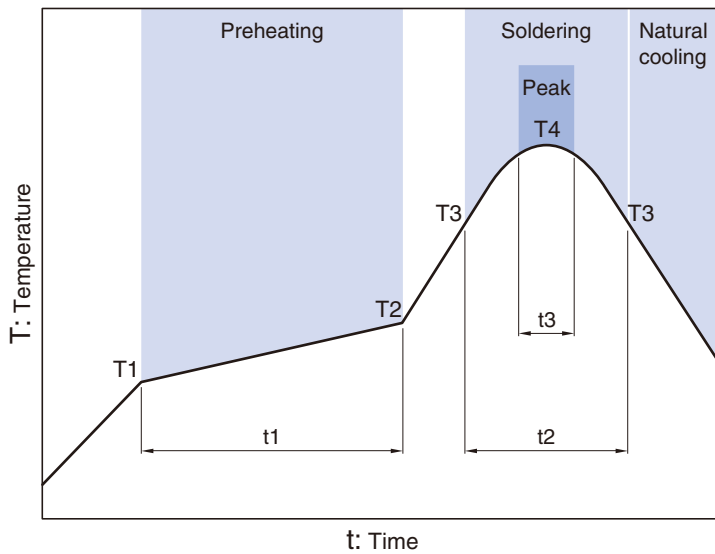
** The Storage temperature range is for after the circuit board is mounted.

- RoHS Directive Compliant Product: See the following for more details related to RoHS Directive compliant products. <http://product.tdk.com/en/environment/rohs/>
- Halogen-free: Indicates that Cl content is less than 900ppm, Br content is less than 900ppm, and that the total Cl and Br content is less than 1500ppm.

 Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use.
Please note that the contents may change without any prior notice due to reasons such as upgrading.

VLS252010HBX-1 Type

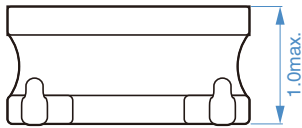
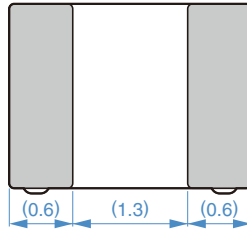
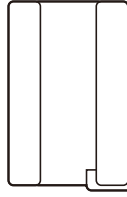
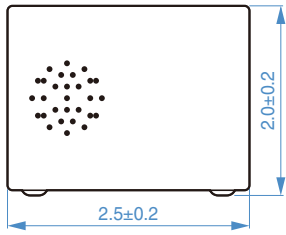
RECOMMENDED REFLOW PROFILE



Preheating			Soldering		Peak	
Temp.	Temp.	Time	Temp.	Time	Temp.	Time
T1	T2	t1	T3	t2	T4	t3
150°C	180°C	60 to 120s	230°C	30s	260°C	10s

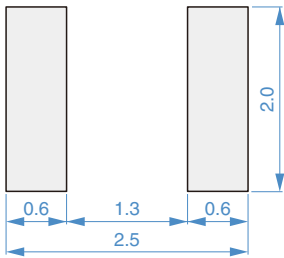
VLS252010HBX-1 Type

SHAPE & DIMENSIONS



Dimensions in mm

RECOMMENDED LAND PATTERN



Dimensions in mm

VLS252010HBX-1 Type

ELECTRICAL CHARACTERISTICS

CHARACTERISTICS SPECIFICATION TABLE

L (μ H)	Tolerance	L measuring frequency (MHz)	DC resistance		Rated current*				Part No.
			(Ω)max.	(Ω)typ.	Isat (A)max.	Itemp (A)max.	Isat (A)typ.	Itemp (A)typ.	
0.24	$\pm 20\%$	1	0.029	0.022	6.55	3.91	7.10	4.60	VLS252010HBX-R24M-1
0.33	$\pm 20\%$	1	0.031	0.025	5.03	3.74	5.46	4.40	VLS252010HBX-R33M-1
0.47	$\pm 20\%$	1	0.035	0.029	4.53	3.32	5.25	3.90	VLS252010HBX-R47M-1
0.68	$\pm 20\%$	1	0.048	0.040	3.62	2.98	4.17	3.50	VLS252010HBX-R68M-1
1.0	$\pm 20\%$	1	0.065	0.054	3.22	2.55	3.57	3.00	VLS252010HBX-1R0M-1
1.5	$\pm 20\%$	1	0.094	0.078	2.70	2.02	3.00	2.38	VLS252010HBX-1R5M-1
2.2	$\pm 20\%$	1	0.120	0.100	2.30	1.76	2.60	2.07	VLS252010HBX-2R2M-1
3.3	$\pm 20\%$	1	0.178	0.148	1.60	1.26	1.90	1.48	VLS252010HBX-3R3M-1
4.7	$\pm 20\%$	1	0.250	0.208	1.40	1.09	1.60	1.28	VLS252010HBX-4R7M-1
6.8	$\pm 20\%$	1	0.406	0.338	1.10	0.75	1.25	0.88	VLS252010HBX-6R8M-1
10	$\pm 20\%$	1	0.552	0.460	0.95	0.68	1.13	0.80	VLS252010HBX-100M-1

* Rated current: smaller value of either Isat or Itemp.

Isat: When based on the inductance change rate (30% below the nominal L value)

Itemp: When based on the temperature increase (Temperature increase of 40°C by self heating)

Measurement equipment

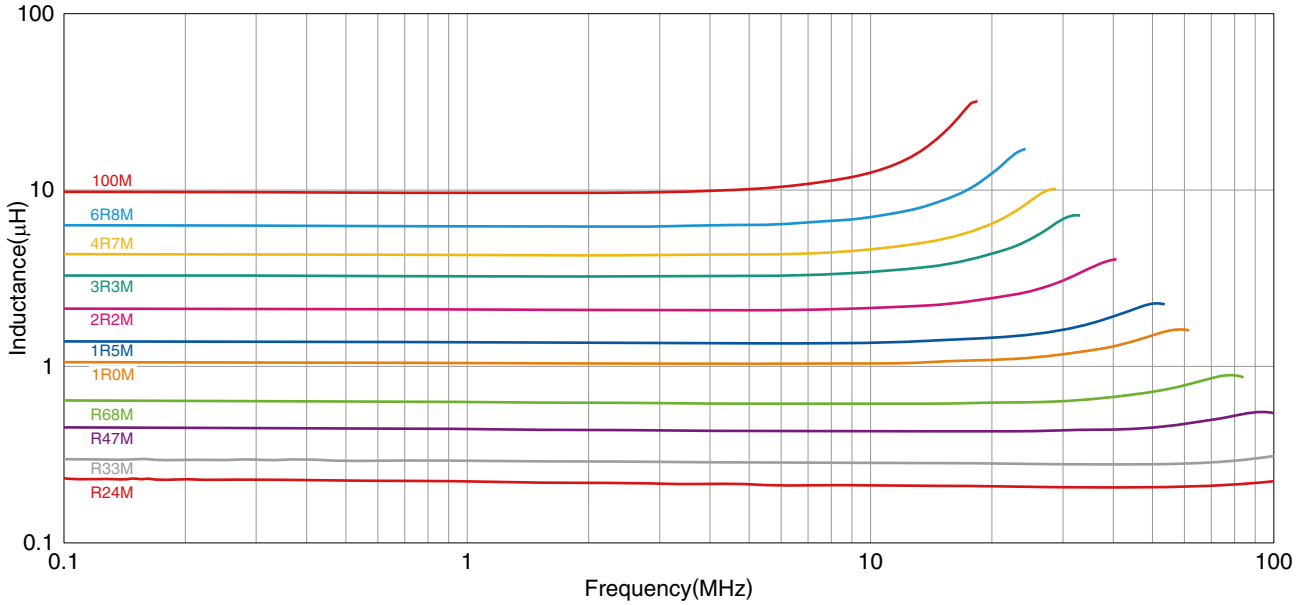
Measurement item	Product No.	Manufacturer
L	4194A	Keysight Technologies
DC resistance	VP-2941A	Panasonic
Rated current Isat	4285A+42841A+42842C	Keysight Technologies

* Equivalent measurement equipment may be used.

VLS252010HBX-1 Type

ELECTRICAL CHARACTERISTICS


L FREQUENCY CHARACTERISTICS GRAPH



○ Measurement equipment

Product No.	Manufacturer
4294A	Keysight Technologies

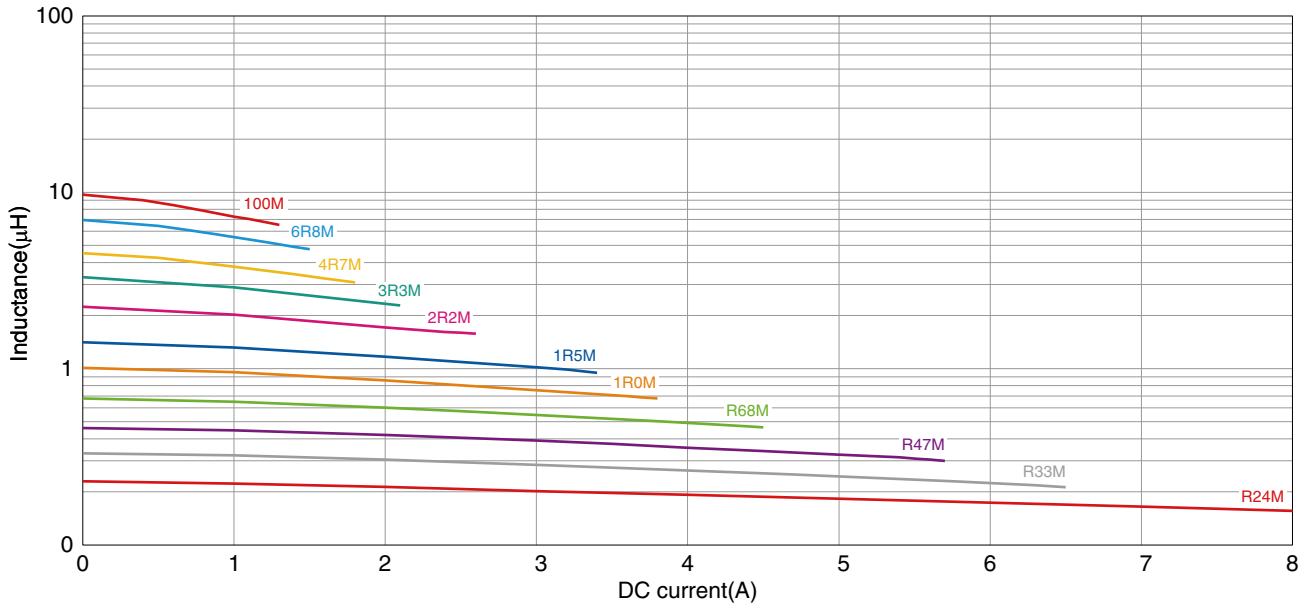
* Equivalent measurement equipment may be used.

 Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use.
Please note that the contents may change without any prior notice due to reasons such as upgrading.

VLS252010HBX-1 Type

ELECTRICAL CHARACTERISTICS


INDUCTANCE VS. DC BIAS CHARACTERISTICS GRAPH



○ Measurement equipment

Product No.	Manufacturer
4285A+42841A+42842C	Keysight Technologies

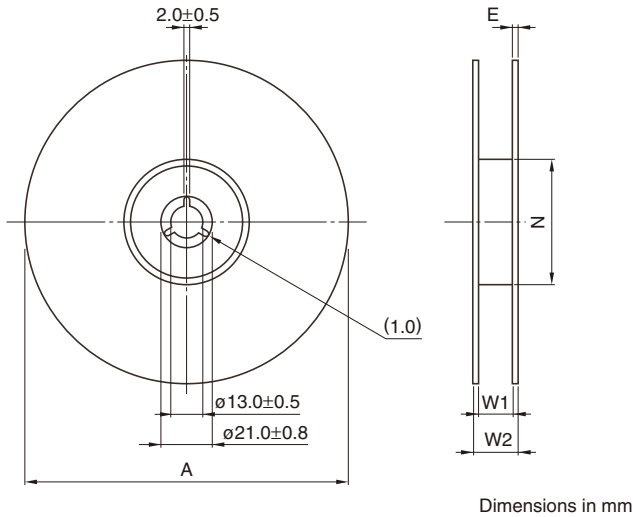
* Equivalent measurement equipment may be used.

 Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use.
Please note that the contents may change without any prior notice due to reasons such as upgrading.

VLS252010HBX-1 Type

PACKAGING STYLE

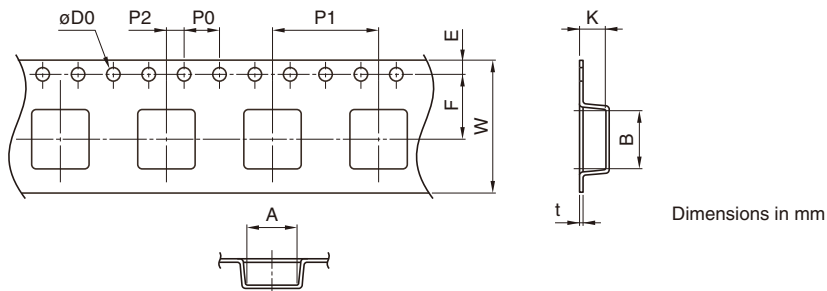
REEL DIMENSIONS



Type	A	W1	W2	N	E
VLS252010HBX-1	φ180	9	10	φ60	0.5

* These values are typical values.

TAPE DIMENSIONS



Type	A	B	φD0	E	F	P0	P1	P2	W	K	t
VLS252010HBX-1	2.3	2.8	1.5+0.1/-0	1.75±0.1	3.5±0.05	4.0±0.1	4.0±0.1	2.0±0.05	8.0±0.2	1.15	0.25